

Lonten N-channel 40V, 47A, 12mΩ Power MOSFET

Description

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and with stand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

Features

- $40V,47A,R_{DS(ON).max}=12m\Omega@V_{GS}=10V$
- Improved dv/dt capability
- Fast switching
- ♦ 100% EAS Guaranteed
- Green device available

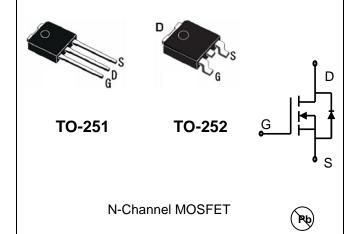
Applications

- Motor Drives
- ◆ UPS
- ♦ DC-DC Converter

Product Summary

 $\begin{array}{ll} V_{DSS} & 40V \\ R_{DS(on).max} @ \ V_{GS} \!\!=\!\! 10V & 12m\Omega \\ I_D & 47A \end{array}$

Pin Configuration



Absolute Maximum Ratings T_c = 25°C unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	40	V
Continuous drain current (T _C = 25°C)	1	47	Α
Continuous drain current (T _C = 100°C)	- I _D	30	Α
Pulsed drain current ¹⁾	I _{DM}	188	Α
Gate-Source voltage	V_{GSS}	±20	V
Avalanche energy ²⁾	E _{AS}	42	mJ
Power Dissipation (T _C = 25°C)	P _D	54	W
Storage Temperature Range	T _{STG}	-55 to +150	°C
Operating Junction Temperature Range	T _J	-55 to +150	°C

Thermal Characteristics

Parameter	Symbol	Value	Unit	
Thermal Resistance, Junction-to-Case	$R_{ heta JC}$	2.3	°C/W	



LNH04R120/LNG04R120

Package Marking and Ordering Information

Device	Device Package	Marking
LNH04R120	TO-251	LNH04R120
LNG04R120	TO-252	LNG04R120

Electrical Characteristics T. = 25°C unless otherwise noted

Electrical Characteristics	$T_J = 25^{\circ}\text{C}$ unless otherwise noted						
Parameter	Symbol Test Condition		Min.	Тур.	Max.	Unit	
Static characteristics							
Drain-source breakdown voltage	BV _{DSS}	V _{GS} =0 V, I _D =250uA	40			V	
Gate threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250uA	1.0		2.0	V	
		V _{DS} =40 V, V _{GS} =0 V, T _J = 25°C			1	μΑ	
Drain-source leakage current	I _{DSS}	V _{DS} =32 V, V _{GS} =0 V, T _J = 125°C			10	μΑ	
Gate leakage current, Forward	I _{GSSF}	V _{GS} =20 V, V _{DS} =0 V			100	nA	
Gate leakage current, Reverse	I _{GSSR}	V _{GS} =-20 V, V _{DS} =0 V			-100	nA	
Paris and a state and interest	Б	V _{GS} =10 V, I _D =20 A		9.2	12	mΩ	
Drain-source on-state resistance	R _{DS(on)}	V _{GS} =4.5 V, I _D =10 A		11.8	16	16 mΩ	
Forward transconductance	g _{fs}	V _{DS} =5 V , I _D =20A		49		S	
Dynamic characteristics							
Input capacitance	C _{iss}			1287		pF	
Output capacitance	C _{oss}	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V},$		165			
Reverse transfer capacitance	C _{rss}	- F = 1MHz		120			
Turn-on delay time	t _{d(on)}			14.8		ns	
Rise time	t _r	$V_{DD} = 20V, V_{GS} = 10V, I_{D} = 10 \text{ A}$		18.7			
Turn-off delay time	t _{d(off)}	V _{DD} = 20V, V _{GS} =10V, I _D =10 A		73.5			
Fall time	t _f]		2.5			
Gate resistance	R_g	V _{GS} =0V, V _{DS} =0V, F=1MHz		4.2		Ω	
Gate charge characteristics							
Gate to source charge	Q_{gs}	V - 20V I - 40A		6			
Gate to drain charge	Q_{gd}	V _{DS} =20V, I _D =10A,		3.2		nC	
Gate charge total	Q_g	- V _{GS} = 10V		24.2			
Drain-Source diode characteristic	s and Maxi	num Ratings		•			
Continuous Source Current	Is				47	Α	
Pulsed Source Current ³⁾	I _{SM}]			188	Α	
Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _S =10A, T _J =25℃			1.2	V	
Reverse Recovery Time	t _{rr}	1 404 divit 4004 / T 07°0		18.2		ns	
Reverse Recovery Charge	Qrr	$I_s=10A, di/dt=100A/us, T_J=25^{\circ}C$		5.5		nC	

Notes:

- 1: Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2: $V_{DD}{=}20V,\,V_{GS}{=}10V,\,L{=}0.5mH,\,I_{AS}{=}13A,\,R_{G}{=}25\Omega,\,Starting\,T_{J}{=}25\,^{\circ}\!\mathrm{C}\,.$
- 3: Pulse Test: Pulse Width $\leq 300 \, \mu \, \text{s}$, Duty Cycle $\leq 2\%$.

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Electrical Characteristics Diagrams

Figure 1. Typ. Output Characteristics

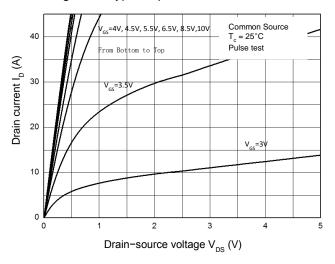


Figure 2. Transfer Characteristics

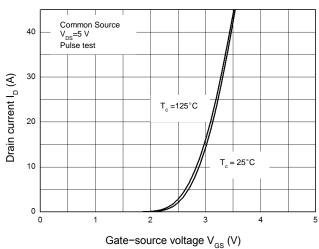


Figure 3. Capacitance Characteristics

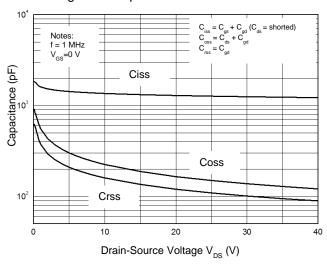


Figure 4. Gate Charge Waveform

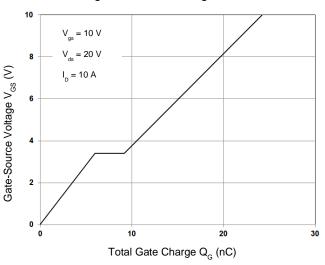


Figure 5. Body-Diode Characteristics

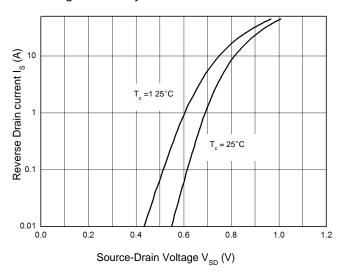
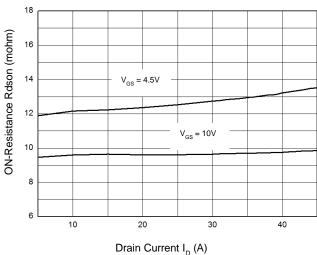


Figure 6. Rdson-Drain Current



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Figure 7. Rdson-Junction Temperature(°C)

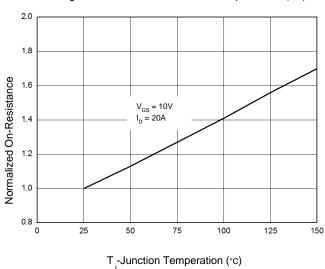


Figure 8. Maximum Safe Operating Area

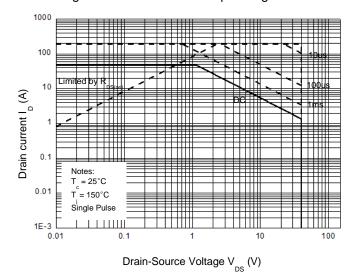
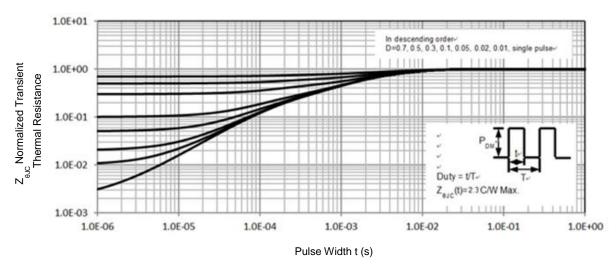


Figure 6. Normalized Maximum Transient Thermal Impedance (RthJC)

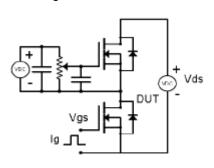


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Test Circuit & Waveform

Figure 8. Gate Charge Test Circuit & Waveform



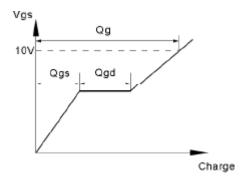
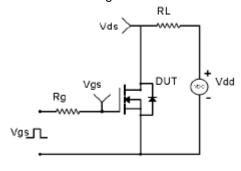


Figure 9. Resistive Switching Test Circuit & Waveforms



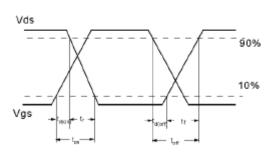
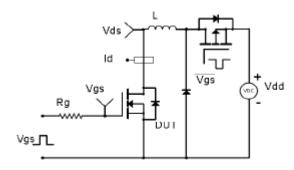


Figure 10. Unclamped Inductive Switching (UIS) Test Circuit & Waveform



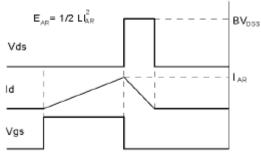
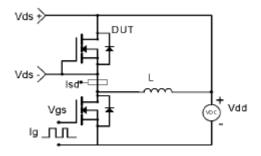
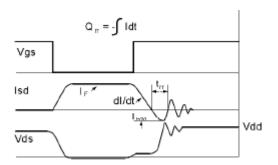


Figure 11. Diode Recovery Circuit & Waveform

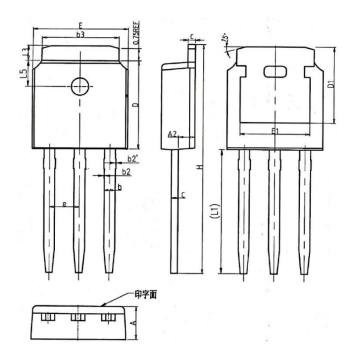




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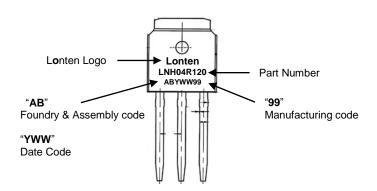


Mechanical Dimensions for TO-251



COMMON DIMENSIONS							
SYMBOL	MM			INCH			
	MIN	NOM	MAX	MIN	NOM	MAX	
Α	2.20	2.30	2.38	0.087	0.091	0.094	
A2	0.97	1.07	1.17	0.038	0.042	0.046	
b	0.68	0.78	0.90	0.027	0.031	0.035	
b2	0.00	0.04	0.10	0.000	0.002	0.004	
b2'	0.00	0.04	0.10	0.000	0.002	0.004	
b3	5.20	5.33	5.46	0.205	0.210	0.215	
С	0.43	0.53	0.61	0.017	0.021	0.024	
D	5.98	6.10	6.22	0.235	0.240	0.245	
D1	5.30REF			0.209REF			
E	6.40	6.60	6.73	0.252 0.260 0.2		0.265	
E1	4.63	-	-	0.182	-	-	
е	2.286BSC			(0.090BS0		
Н	16.22	16.52	16.82	0.639	0.650	0.662	
L1	9.15	9.40	9.65	0.360	0.370	0.380	
L3	0.88	1.02	1.28	0.035	0.040	0.050	
L5	1.65	1.80	1.95	0.065	0.071	0.077	

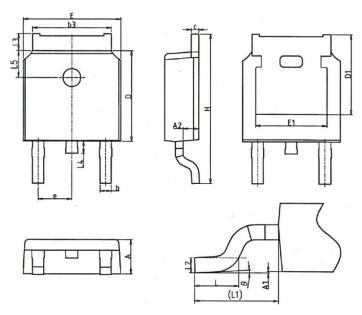
TO-251 Part Marking Information



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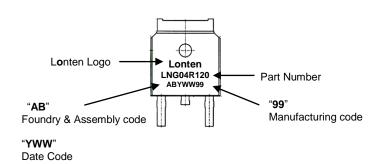


Mechanical Dimensions for TO-252



COMMON DIMENSIONS							
SYMBOL MM			INCH				
STIVIBUL	MIN	NOM	MAX	MIN	NOM	MAX	
А	2.20	2.30	2.38	0.087	0.091	0.094	
A1	0.00	-	0.20	0.000	-	0.008	
A2	0.97	1.07	1.17	0.038	0.042	0.046	
b	0.68	0.78	0.90	0.027	0.031	0.035	
b3	5.20	5.33	5.46	0.205 0.210 0.2			
С	0.43	0.53	0.61	0.017	0.021	0.024	
D	5.98	6.10	6.22	0.235	0.240	0.245	
D1	5.30REF			0.209REF			
Е	6.40	6.60	6.73	0.252	0.260	0.265	
E1	4.63	-	-	0.182	-	1	
е		2.286BSC			0.090BSC		
Н	9.40	10.10	10.50	0.370	0.398	0.413	
L	1.38	1.50	1.75	0.054	0.059	0.069	
L1	2.90REF				0.114REF		
L2	0.51BSC			0.020BSC			
L3	0.88	-	1.28	0.035	-	0.050	
L4	0.50	-	1.00	0.020	-	0.039	
L5	1.65	1.80	1.95	0.065	0.071	0.077	
θ	0°	-	8°	0°	-	8°	

TO-252 Part Marking Information



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